

Description

The EG01A is a fast recovery diode of 600 V / 0.5 A. The maximum $t_{\rm rr}$ of 100 ns is realized by optimizing a life-time control.

Features

•	V _{RM} 600	V
•	$I_{F(AV)}0.5$	A
•	V_F 2.0	V
•	t_{rr1} 100 t_{rr1}	ns

• Bare Leads: Pb-free (RoHS Compliant)

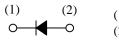
Applications

- Secondary Side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck and Buck-boost Converter)

Package

Axial ($\phi 2.7 \times 5.0 L / \phi 0.6$)





- (1) Cathode
- (2) Anode

Not to scale

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C

Parameter	Symbol	Conditions	Rating	Unit
Peak Repetitive Reverse Voltage	V_{RSM}		600	V
Repetitive Reverse Voltage	V_{RM}		600	V
Average Forward Current	I _{F(AV)}	See Figure 2 and Figure 3	0.5	A
Surge Forward Current	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	10	A
I ² t Limiting Value	I ² t	$1 \text{ ms} \le t \le 10 \text{ ms}$	0.5	A^2s
Junction Temperature	T_{J}		-40 to 150	°C
Storage Temperature	T_{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
E. a. I.W. Koo a Door	V_{F}	$T_J = 25 ^{\circ}\text{C}, I_F = 0.5 \text{A}$	_	_	2.0	V
Forward Voltage Drop		$T_J = 100 ^{\circ}\text{C}, I_F = 0.5 \text{A}$	_	1.0	_	V
Reverse Leakage Current	I_R	$V_R = V_{RM}$	_	_	100	μΑ
Reverse Leakage Current Under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 100 ^{\circ}C$	_	_	500	μΑ
	t_{rr1}	$I_F = I_{RP} = 100 \text{ mA}$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$	_	_	100	ns
Reverse Recovery Time	t _{rr2}	$I_F = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ $75\% \text{ recovery point},$ $T_J = 25 \text{ °C}$	_	_	50	ns
Thermal Resistance (1)	R _{th(J-L)}	See Figure 1	_		20	°C/W

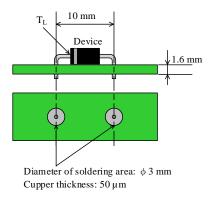


Figure 1 Lead Temperature Measurement Conditions

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 $^{^{(1)}\,}R_{\text{th}\,(J\text{-}L)}$ is thermal resistance between junction and lead.

Rating and Characteristic Curves

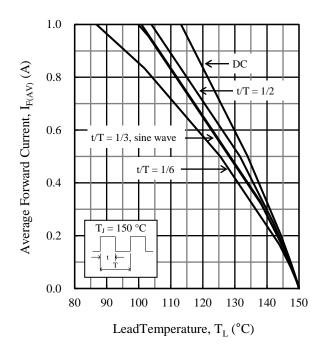


Figure 2. $I_{F(AV)}$ vs. T_L Typical Characteristics⁽²⁾ $(V_R = 0 \ V)$

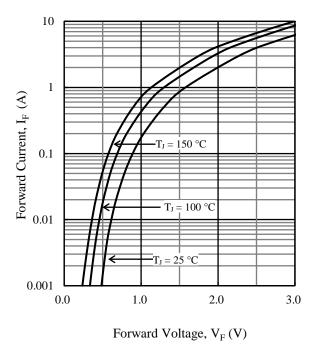


Figure 4. V_F vs. I_F Typical Characteristics

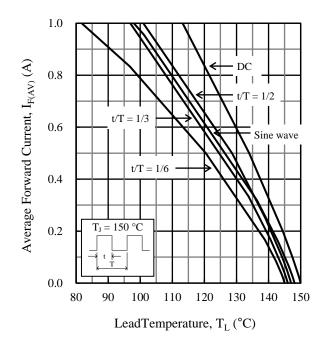


Figure 3. $I_{F(AV)}$ vs. T_L Typical Characteristics⁽²⁾ $(V_R = 600 \ V)$

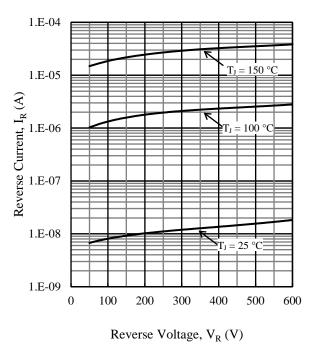
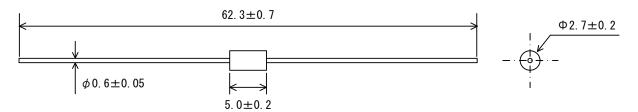


Figure 5. V_R vs. I_R Typical Characteristics

⁽²⁾ See Figure 1 for the lead temperature measurement conditions.

Physical Dimensions

• Axial $(\phi 2.7 \times 5.0 L / \phi 0.6)$



NOTES:

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits: Flow: 260 ± 5 °C / 10 ± 1 s, 2 times Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

Marking Diagram

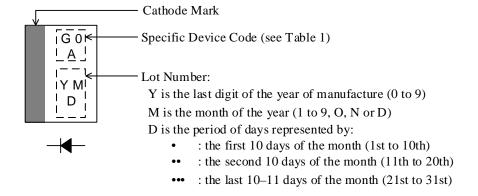


Table 1. Specific Device Code

Specific Device Code	Part Number
G0A	EG01A

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